



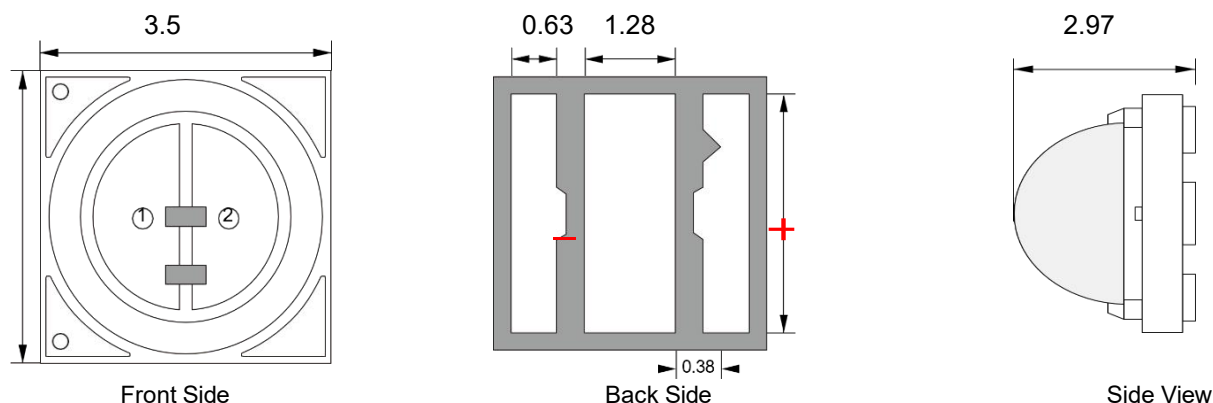
PPZ2020T3D

Product Datasheet SPECIFICATIONS

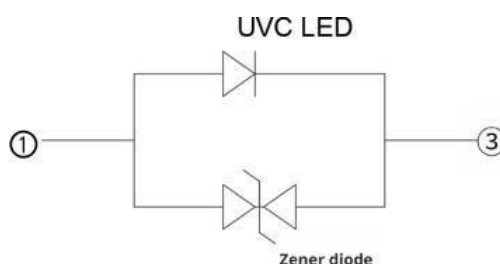
We take care of your health with UVC

Pueple Planet UVC PKG

1 DEVICE DIMENSIONS



1.1 Circuit Connection



Notes :

- [1] Each device integrates two different chips: a UVC chip and a Zener diode. The Zener diode provides ESD protection for the UVC LED.
- [2] Package Dimensions: $3.5 \times 3.5 \times 2.97$ (L $\times$ W $\times$ H) [Unit: mm];
- [3] As shown in the diagram above, ① is the positive terminals, ② is the negative terminals: The center pad is the thermal pad
- [4] T The notch on the front side indicates the negative electrode, and the chamfer on the back side also indicates the negative electrode. For taped products, the round-hole side indicates the negative electrode. The actual product may not have a chamfer mark on the back side; please refer to Section [3] for the correct polarity identification. y;
- [5] Slight appearance variations may occur due to different bracket batches. Products remain compatible and functional.;
- [6] Dimensional Tolerance: ± 0.2 mm.

2 Optoelectrical Characteristics

2.1 UVC Optoelectrical Parameters and SPEC Range @ 40mA (Ta = 25°C, RH = 30%)

Parameter	Symbol	Min	Max	Step	Unit
UVC Peak Wavelength	λ_P	270	280	10	nm
UVC Radiant Power	P_0	20	40	5	mW
UVC Forward Voltage	V_f	5.4	6.2	0.2	V

Wavelength Range:

Bin Code	W01
Range (nm)	270~280

Radiant Power Range:

Bin Code	P001	P002	P003	P004
Range (mW)	20~25	25~30	30~35	35~40

Forward Voltage Range:

Bin Code	V11	V12	V13	V14
Range (V)	5.4~5.6	5.6~5.8	5.8~6.0	6.0~6.2

Note:

[1] UVC Maximum Operating Current: 150mA 。

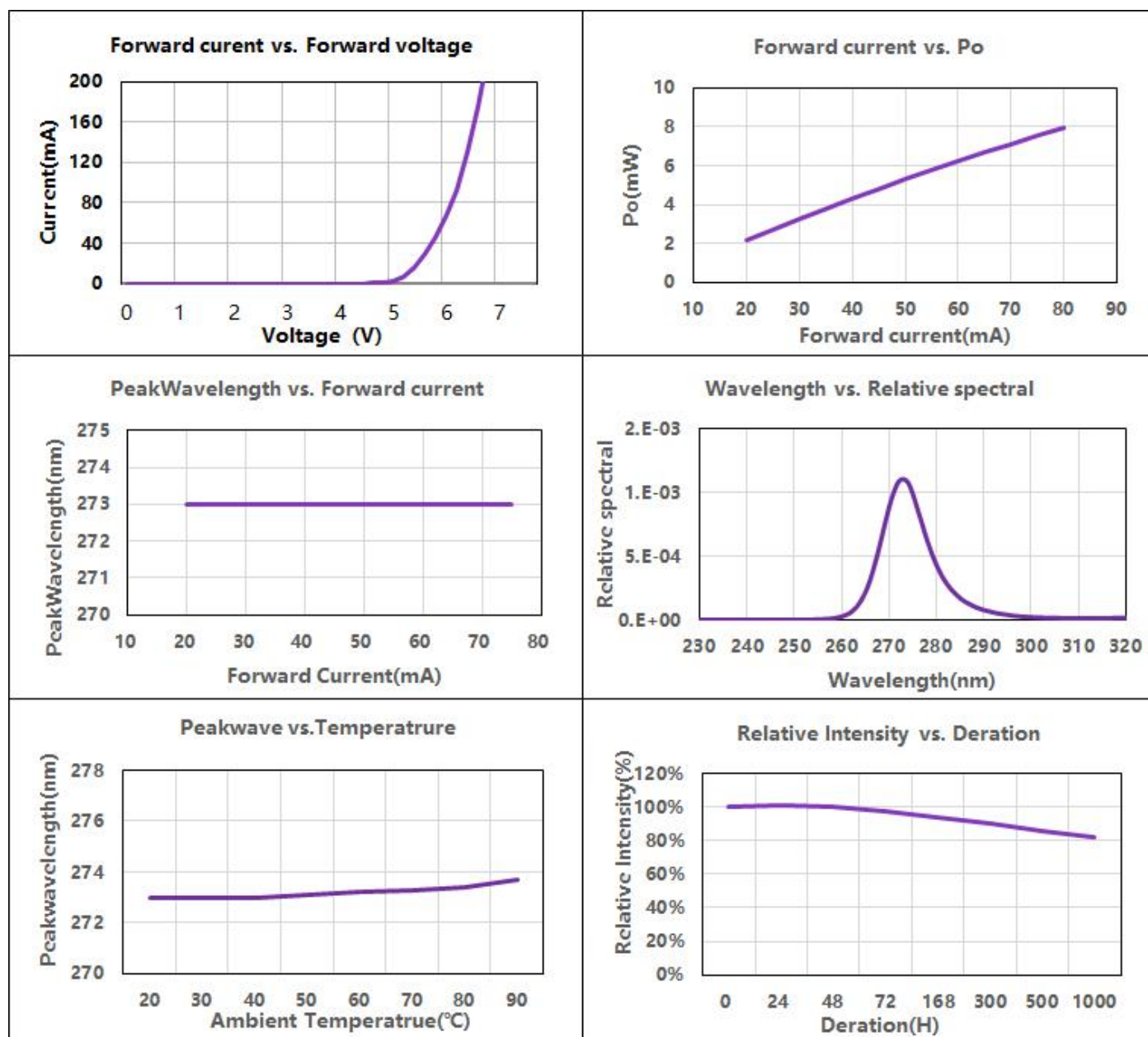
2.2 Absolute Maximum Ratings

Parameter	Sybol	Value			Unit
		Min		Max	
Operating Temperature	Topr	-30		60	°C
Storage Temperature	Tstg	-40		100	°C
Thermal Resistance	Rjs				K/W

Note:

- [1] Radiant power refers to the total optical output power collected by an integrating sphere.
- [2] All data are based on the test results obtained using Huaai Technology testing equipment. The measurement tolerances of forward voltage, peak wavelength, and radiant power are $\pm 0.2V$, $\pm 3nm$, and $\pm 10\%$, respectively. An increase in drive current will result in a higher operating temperature, accelerate LED light degradation, and shorten the product lifetime. Testing or operating the device beyond the above absolute maximum ratings may affect device reliability and cause permanent damage.
- [3] A proper heat dissipation environment or thermal management system is recommended during operation to achieve optimal performance.

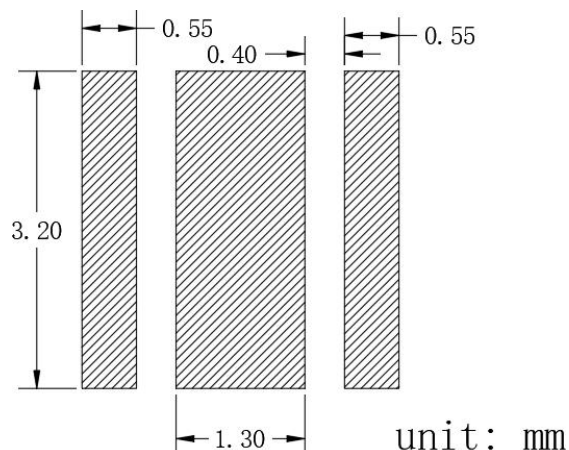
2.3 Characteristic Curve (UVC Chip)



Note:

The above test data may vary depending on sampling conditions; actual curves may differ slightly.

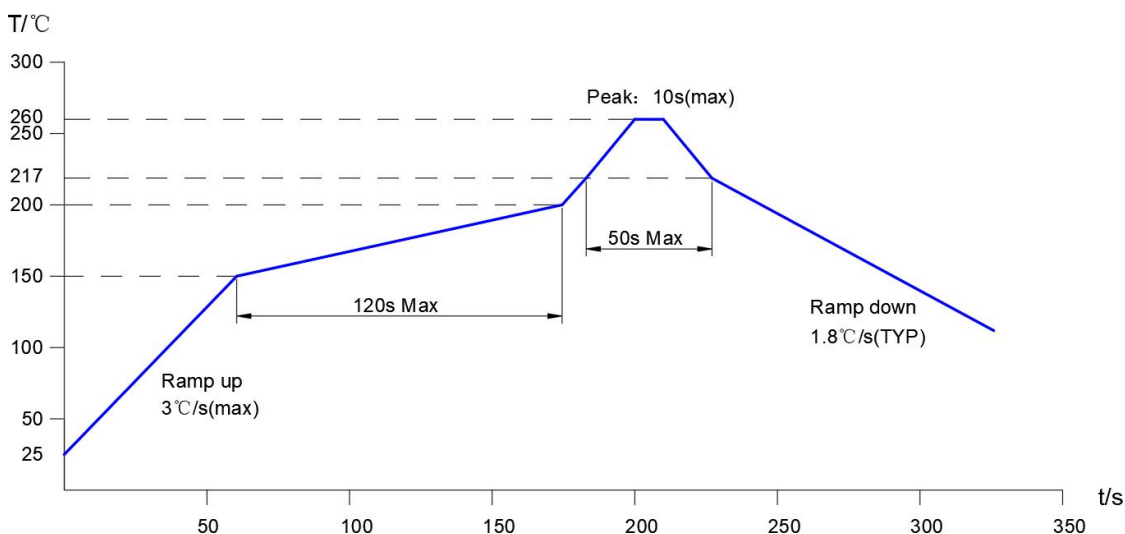
3 Recommended Pad Design



Note:

[1] The above pad design is for reference only.

4 Reflow Process



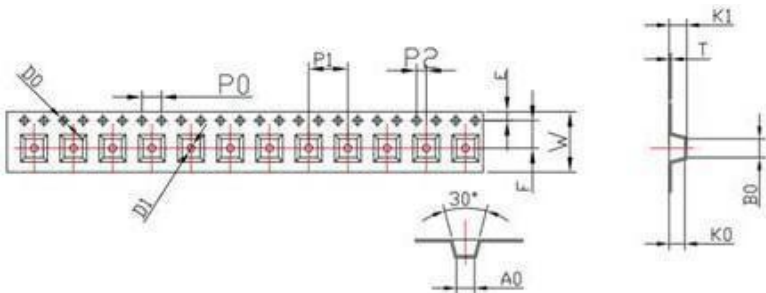
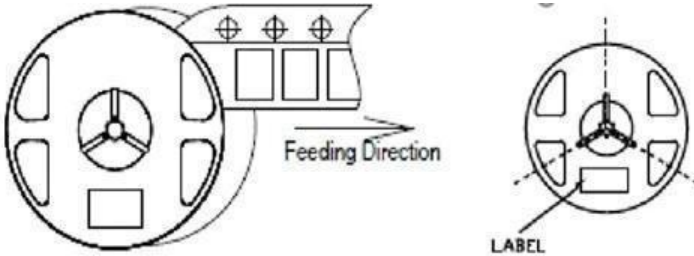
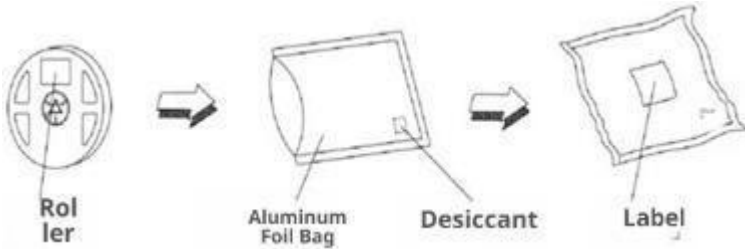
Surface mounting should use **high-temperature solder paste** for reflow soldering. The peak temperature **should not exceed 260°C**, peak time should be controlled within 10 seconds, and total reflow time should not exceed 5 minutes.

Note:

- 1 Reflow soldering should not be performed more than once;
- 2 Repair after UVC soldering is not recommended. If repair is unavoidable, a dual-tip soldering iron must be used, and careful operation is required to avoid damaging the product itself. Do not apply pressure to the LED during heating and soldering;
- 3 A convection reflow oven with more than 7 heating zones is recommended.

5 Packaging Specification

5.1 Packaging Description

Carrier Tape	 Diagram illustrating the carrier tape dimensions and components. The tape is shown with dimensions AO, BO, KO, PO, P, P2, W, T, E, F, D1, and A0. A 30° angle is indicated for the carrier tape. A cross-section view shows dimensions K1, T, B0, and K0. <table><tr><td>symbol</td><td>AO</td><td>BO</td><td>KO</td><td>PO</td><td>P</td><td>P2</td><td>长度/盘</td></tr><tr><td>Spec</td><td>3.90±0.1</td><td>3.90±0.1</td><td>1.60±0.1</td><td>4.0±0.10</td><td>8.0±0.1</td><td>2.00±0.10</td><td>400M</td></tr><tr><td>symbol</td><td>W</td><td>T</td><td>E</td><td>F</td><td>D</td><td>D1</td><td>元件/盘</td></tr><tr><td>Spec</td><td>12.0±0.3</td><td>0.30±0.05</td><td>1.75±0.10</td><td>5.5±0.1</td><td>1.50^{+0.1}_{-0.1}</td><td>1.50±0.10</td><td></td></tr></table>	symbol	AO	BO	KO	PO	P	P2	长度/盘	Spec	3.90±0.1	3.90±0.1	1.60±0.1	4.0±0.10	8.0±0.1	2.00±0.10	400M	symbol	W	T	E	F	D	D1	元件/盘	Spec	12.0±0.3	0.30±0.05	1.75±0.10	5.5±0.1	1.50 ^{+0.1} _{-0.1}	1.50±0.10	
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Reel	 Diagram illustrating the reel packaging. The reel is shown with dimensions and a feeding direction arrow. A label is indicated on the reel.																																
Aluminum Foil Bag Packaging	 Diagram illustrating the aluminum foil bag packaging process. The process involves a roller, aluminum foil bag, desiccant, and label.																																

Note:

- [1] The carrier outward tilt angle shall not exceed 1mm/100mm, with a length of 250mm;
- [2] All dimensions comply with EIA-481-B requirements;
- [3] Material: Conductive polyester polystyrene plastic.

6 Reliability Test

Test Item	Test Condition	Criteria	Failure Rate
Normal Drive	T =25°C, Rated Current, Continuous Lighting 1000 Hours	LED Failure	0/35
Thermal Shock	Thermal Shock Test: -40°C ↔ 120°C, 500 cycles, 15 min per cycle	LED Failure	0/35
Reflow Soldering	Peak Temperature <170°C, 10-zone reflow oven, 1 cycle	LED Failure	0/100
ESD Resistance	R=1.5kΩ, C=100pF, Voltage level=2kV	LED Failure	0/10

7 Usage Risks



Note:

- [1] All assembly workers, inspectors, and bystanders must wear eye and skin protection;
- [2] Direct observation with naked eyes (including through a microscope) and exposed handling of deep UV LEDs during operation are strictly prohibited.
- [3] Deep UV light can be easily absorbed by contaminants. Do not touch the optical structure of the deep UV LED;
- [4] This product is moisture-sensitive. The recommended storage conditions are 18°C–30°C with a relative humidity of 30%–60%, and the product should be stored in sealed packaging. To ensure product quality, unopened packages should be used within one year after shipment. Once the package is opened, the product should be used within 24 hours. If the exposure time exceeds 24 hours, the product must be resealed and stored properly. Before reuse, dehumidification is recommended at 65°C for 5 hours.